



In the United States Patent and Trademark Office

Applicants: Julia S. Svirchevski et al.	Examiner: Unassigned Group Art Unit: 1765 Date: June 15, 2000
Applicants' Reference: LAM1P109 Application No. 09/336,401	
Filed: June 18, 1999	
Title: POST-PLASMA PROCESSING WAFER CLEANING METHOD AND SYSTEM	

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231 on June 15, 2000.

Signed:

Diane Schwanbeck

Separate Letter to the Official Draftsperson

Assistant Commissioner for Patents Box: Official Draftsperson Washington, D.C. 20231

Dear Sir:

Applicants hereby attach twelve (12) sheets of formal drawings (Figures 1A, 1B, 1C, 1D, 1E, 2A, 2B, 2C, 2D, 3A, 3B, 3C, 3D, 4, 5, and 6) for the above-referenced patent application. In the event the Draftsperson has any questions concerning the formal drawings, he or she is respectfully requested to contact the undersigned. If any fees are due in connection with the filing of these drawings, then please charge such fees to our Deposit Account No. 50-0805 (Order No. <u>LAM1P109</u>).

Respectfully submitted, MARTINE PENILLA & KIM, LLP

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